

APPLICATION DATA SHEET

APPLICATION INFORMATION

Application Type:: REGULAR
Subject Matter:: UTILITY
CD-ROM or CD-R?:: NONE
Title:: WAFER PROCESSING APPARATUS
HAVING WAFER MAPPING FUNCTION
Attorney Docket Number:: 245436US2
Total Drawing Sheets:: 11
Small Entity?:: NO

INVENTOR INFORMATION

Applicant Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Jun
Family Name:: EMOTO
Street of Mailing Address:: c/o TDK CORPORATION
1-13-1, Nihonbashi, Chuo-ku,
City of Mailing Address:: Tokyo
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 103-8272

Applicant Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Takeshi
Family Name:: KAGAYA
Street of Mailing Address:: c/o TDK CORPORATION
1-13-1, Nihonbashi, Chuo-ku,
City of Mailing Address:: Tokyo
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 103-8272

Applicant Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Kazuo
Family Name:: YAMAZAKI
Street of Mailing Address:: c/o TDK CORPORATION
1-13-1, Nihonbashi, Chuo-ku,
City of Mailing Address:: Tokyo
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 103-8272

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 22850

REPRESENTATIVE INFORMATION

Representative Customer Number:: 22850

FOREIGN PRIORITY INFORMATION

Application Number:	Country::	Filing Date::	Priority Claimed::
2002-331868	Japan	11/15/02	YES

ASSIGNMENT INFORMATION

Assignee Name:: TDK CORPORATION
Street of Mailing Address:: 1-13-1, Nihonbashi, Chuo-ku,
City of Mailing Address:: Tokyo
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 103-8272